



2nd Draft **ISO/IEC JTC 1/SC 25/WG 3 N 764**

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Customer Premises Cabling
Secretariat: Germany (DIN)

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TITLE: Draft liaison report to the IEEE 802.3at PoEP Task Group on power feeding via balanced channels
SOURCE: WG 3 Secretariat
(v. Pattay)
PROJECT: 25.03.02.xx: Generic cabling for customer premises
STATUS: Draft to be developed by correspondence as requested for by WG 3 at Edinburgh, UK, 2005-09-26/29 and subject to synchronisation with IEC SC 46C & SC 48B as requested by SC 25 plenary 2005-09-30.
1st Step the draft is sent to SC 25/WG 3 experts for comments (due to their meeting schedules IEEE 802.3at PoEP, IEC SC 46C & SC 48B are already included in this comment cycle with the request for input).
2nd step the completed draft is sent to IEC SC 46C & SC 48B with the request to include answers to the open questions and for endorsement/update of data on their products already included.
3rd step the liaison report is completed and forwarded to IEEE 802.3.
ACTION ID: FYI
DUE DATE: 2005-11-04
REQUESTED ACTION: This draft is distributed in SC 25/WG 3 with the kind request for comments. Should IEEE 802.3, IEC SC 406C and SC 48B already have comments at that early status they will also be taken into account.
MEDIUM: Def
NOTE: Electronically this document consists of two files: WG3N764c and WG3N764x.

No of Pages: 7 (including cover)

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1 SC 25/WG 3 is pleased to address the needs of IEEE 802.3 as to power feeding over the
2 premises cabling system.

3 Though SC 25/WG 3 is happy to share its findings with IEEE 802.3at, SC 25/WG 3 has to
4 emphasise the fact that these findings have to be considered as preliminary as many findings
5 are subject to confirmation by the relevant component committees, i.e. IEC 46C and IEC 48B.

6 **1 Introduction**

7 In its investigations on the power carrying capacity of balanced cabling channels, ISO/IEC
8 JTC 1/SC 25/WG 3 has identified three fields of investigation that are discussed under point
9 3 for cables and point 4 for connecting hardware and that need to be further explored:

10 **1. Change of transmission characteristic**

11 **2. Long term stability**

12 **3. Safety and local regulations**

13 It should be noted, that the channel carrying performance is determined per characteristic by
14 the component with the lowest performance.

15 During its investigations SC 25/WG 3 also has identified a number of questions to
16 IEEE 802.3at which are addressed in point 0 below.

17 To simplify matters the relevant articles of ISO/IEC 11801:2002 are listed under point 2.
18 further details on the application and its wishes are provided in point 7.

19 **2 Content of ISO/IEC 11801:2002**

20 **4 Conformance**

21 h) Regulations on safety and EMC applicable at the location of the installation shall be met.

22 **6.4.9 Current carrying capacity (of the channel)**

23 The minimum current carrying capacity for channels of Classes D, E and F shall be 0,175 A d.c. per
24 conductor for all temperatures at which the cabling will be used. This shall be achieved by an
25 appropriate design.

26 **6.4.10 Operating voltage (of the channel)**

27 The channels of classes D, E and F shall support an operating voltage of 72 V d.c. between any
28 conductors for all temperatures at which the cabling is intended to be used.

29 **6.4.11 Power capacity (of the channel)**

30 The channels of classes D, E and F shall support the delivery of a power of 10 W per pair for all
31 temperatures at which the cabling is intended to be used.

32 It should be noted that all three values specify maxima for the application that all apply
33 individually and therefore can not be exploited at the same time.

34 **Table 21 of ISO/IEC 11801**

35 specifies the worst-case for the degradation of insertion loss of balanced channels for
36 operating temperatures above 20 °C, with 0,2 % per °C for channels implemented with
37 screened cables; and with 0,4 % per °C (20 °C to 40 °C) and 0,6 % per °C (>40 °C to 60 °C)
38 for unscreened cables.

39 Implicitly the values specified in table 21 also characterise the cables.

40 **9.2.2.6 Current carrying capacity (of the cable)**

41 Minimum d.c. current carrying capacity per conductor shall be 175 mA. This shall be supported at a
42 maximum ambient temperature of 60 °C

43 **Table 38 – Current carrying capacity (of IEC 60603-7 connecting hardware)**

Electrical characteristics	Frequency	Requirement			Test standard
		Connector category			
		5	6	7	
Minimum current carrying capacity ^{a, b, c} A	d.c.	0,75	0,75	0,75	IEC 60512-3 Test 5b
^a Applicable for an ambient temperature of 60 °C. ^b Sample preparation shall be as specified in IEC 60603-7 (unscreened) or IEC 60603-7-1 (screened). ^c Applicable to each conductor including the screen, if present.					

44

45 **3 Cables**

46 **3.1 Change of transmission characteristics**

47 The following characteristics may change with temperature:

- 48 a) The worst-case effect of temperature according to the present knowledge of SC 25/WG 3
49 is on the attenuation.
- 50 b) The phase angle and as a result the propagation velocity are expected to be only to a
51 minor degree affected.
- 52 c) The delay skew is, as a result, should be affected in a negligible way.
- 53 d) NEXT (expectations no more than ~ 0,5 dB on 100 m of cable)
- 54 e) ELFEXT and ACR-F (mainly due to the impact of the attenuation).
- 55 f) The impedance should be relatively stable over temperature range considered here.

56 The following changes of transmission characteristics have been confirmed by IEC SC 46C:

57 *Room for additional input from IEC SC 46C*

58 SC 25/WG 3 expects IEC SC 46C to provide further verification/quantification of cable
59 behaviour.

60 Therefore IEEE 802.3 is kindly asked to note that these investigations may take some time
61 since readily available data implies that the currents carried are so small as to allow
62 assuming that the conductor surface temperature and the ambient operating temperature are
63 practically equal.

64 **3.2 Long term stability**

65 This issue affects the main two components of the cabling channels, i.e. cables and
66 connectors in a different way that need further investigations.

67 Cables, long term exposed to elevated temperatures (aging and eventually humidity), may be
68 affected in their performances. The range of possible effects is expected to be considerable
69 depending on their design and the materials used.

70 *Room for input from IEC SC 46C*

71 **3.3 Safety and compliance to local regulations**

72 Safety is not covered in ISO/IEC 11810, as it is normally a locally regulated issue (see
73 excerpt from clause 4 of ISO/IEC 15018 copied above) as it is outside the scope of SC 25,
74 and WG 3 can only indicate areas of possible concern.

75 Such concerns have been expressed and led to three questions.

76 Could the current asked for by IEEE 802.3 make the IT cables subject to power cable
77 regulations?

78 Could the current asked for by IEEE 802.3 heat the IT cables beyond the temperature they
79 have been rated for?

80 Could the current asked for by IEEE 802.3 heat the IT cables to temperatures that are not
81 considered to be safe?

82 These questions need and will be investigated by SC 25.

83 *Room for additional input from IEC SC 46C*

84 **4 Connecting hardware**

85 **4.1 Change of transmission characteristics**

86 **Un-plugging under load:** The specifications of IEC 60603-7 so far do not contain
87 requirements for mating and un-mating under load. IEC 60512-9-3 specifies a test method to
88 qualify any connector for those characteristics. Also ISO/IEC 11801 so far neither requires
89 that the connector (according to IEC 60603-7-x or IEC 61076-3-104) used within any channel
90 specified in ISO/IEC 11801 needs to pass the test according to IEC 60512-9-3 nor does it
91 specify the limits for such a test that would be appropriate for generic cabling channels .

92 *Room for additional input from IEC SC 48B*

93 **4.2 Long term stability**

94 Connectors are affected in their long term stability primarily due to the anticipated plugging
95 and unplugging, where primarily the latter may be under load. This may result in a change of
96 performance with respect to contact resistance, and may have as a result also an impact on
97 the consecutive heating of the connector under load. Depending on the specific construction
98 such effects could be dramatic.

99 *Room for additional input from IEC SC 48B*

100 **4.3 Safety and local regulations**

101 Again, safety of the connecting hardware is not covered in ISO/IEC 11810, as it is normally a
102 locally regulated issue. Safety is outside the scope of SC 25/WG 3.

103 IEC SC 48B has emphasised in a liaison document (Zurich 17) that safety is the responsibility
104 of the application that uses connecting hardware. The mating interface of IEC 60603-7 itself
105 is not designed to fulfil the safety requirements to prevent users from electrical shock (i.e.
106 finger probe test according to IEC 60529).

107 *Room for additional input from IEC SC 48B*

108 **5 Questions to IEEE 802.3**

109 IEEE 802.3 needs to clarify the circuit components representing the load for un-plugging. So
110 far IEEE 802.3 indicates 0,420 A for the component calculation, though the actual current,
111 according to the sketch, over the common mode circuit of two pairs is 0,840 A. The
112 components representing the worst case capacitance and inductance of the channel will have
113 to be added to this circuit in determining the requirements for the test according to
114 IEC 60512-9-3.

115 Could you please confirm, that your application would only put power on the channel ?? ms
116 after the terminal has been connected, that the power will be switched of before intended and
117 within 500 ms after unintended disconnection of the terminal. These values are essential for
118 the input expected from IEC SC 48B.

119 What is the maximum current in any direction, irrespective of the number of pairs shared?
120 There may be cases where the full current will flow through a single conductor, since the
121 contact break upon unplugging will definitely occur sequentially, so concentrating the current
122 on the last mated conductor.

123 *Room for additional input from IEEE 802.3*

124 **6 Preliminary conclusion**

125 SC 25/WG 3 notes that ISO/IEC 11801 specifies generic channels that are capable to support
126 all the applications satisfied within the frequency range a specific channel is specified.

127 Please also note that SC 25 may only specify the characteristics of channels installed after
128 publication of the appropriate standard. SC 25 also notes that up to now it was a basic
129 assumption to ISO/IEC 11801 that the conductor surface temperature and the ambient
130 operating temperature are practically equal.

131 SC 25 is concerned primarily with the transmission performance of channels, while physical
132 safety, construction of components and behaviour of material belong to the scope of other
133 committees.

134 SC 25 – even with help of the component committees – is not optimistic with respect to
135 finding a widely applicable way to qualify channels for power distribution exceeding the level
136 of a specific installation at the time of installation retroactively. The qualification of installed
137 channels would require knowledge about components' construction and materials that can
138 not be acquired with measurement of installed channels. In many cases only the source of
139 the component itself will be able to provide such data. Nevertheless SC 25 attempts to
140 identify ranges of environmental conditions and component constructions that have a
141 reasonable probability to work above the minimum specified in ISO/IEC 11801.

142 NOTE While ISO/IEC 11810 specifies the **minimum** performance a channel has to provide in order to meet the
143 standard, this same value from the point of view of the application it is the **maximum** value it may expect from any
144 channel installed according to this standard.

145 This may also lead to the specification of additional environmental and possibly other
146 conditions that need to be met in order to exploit the 175 mA presently specified.

147 SC 25 anticipates that the cable committee will recommend a reduction of the maximum
148 applicable ambient operating temperature. Whether the cable industry will also offer solutions
149 for an ambient temperature of 60 °C and what (additional) conditions need to be met so that
150 such solutions are authorised by regulatory bodies is open.

151 The intent to go to higher currents than 175 mA on channels implemented with current
152 constructions of cables and IEC 60603-7-x connectors raises concerns that need further
153 investigation. To meet this intent is expected to require changes to component specifications
154 that need to be justified by a significant gain in user benefit. Explanations of that user benefit
155 would be welcome.

156 **7 Further information on the application**

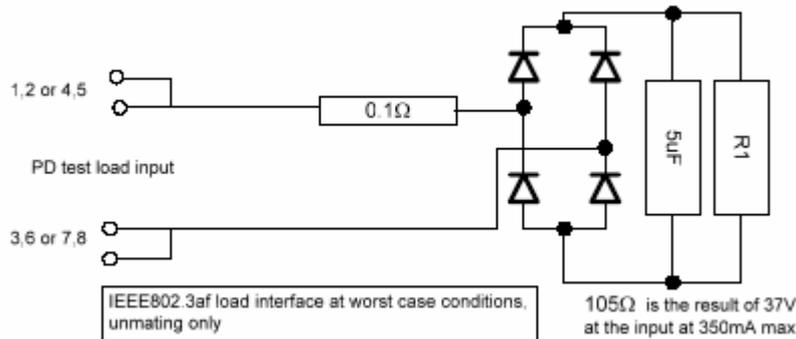
157 **7.1 Request for higher current and power**

158 The IEEE PoEPlus Study Group is investigating raising the current above the 175 mA
159 minimum capability specified in ISO 11801 section 6.4.9. We have not yet determined an
160 appropriate maximum current, but are evaluating currents as high as 420 mA per conductor
161 and operating at a maximum voltage of 57 Vdc. We require guidance from SC25 on how to
162 achieve these goals on installed cabling.

163 **7.2 Decreased requirement on connecting hardware**

164 IEEE Std 802.3af-2003 loads are not consistent with the circuit used to test connector mating
165 and unmating under load. Specifically, our devices ensure that:

- 166 • sources and loads are never active during mating, and,
- 167 • the load during unmating is as shown in the schematic below:



168
169 Given the load circuit above and an appropriate power source which powers the load only
170 after mating has completed, what would be the maximum load which may be repetitively
171 unplugged without performance degradation? Note that in the above circuit with $R1=105\Omega$
172 this would represent a 13 Watt load at 37 Vdc, which is the worst case for IEEE Std 802.3af-
173 2003; however, as stated earlier we are evaluating 51 Vdc and 420 mA per conductor which
174 would require $R1=60\Omega$.

175 **7.3 Details on current hoped for**

176 ISO 11801 specifies the minimum current capacity to be 175 mA per conductor while IEEE
177 Std 802.3af-2003 specifies the maximum sustained current per conductor pair to be 350 mA
178 with a maximum conductor imbalance of 10,5 mA. The standard also allows for up to 50 ms
179 of operation at currents as high as 400 mA limited to a duty cycle of no more than 5%. Do
180 these minor variations merit further investigation?

181

182 *Room for additional input from IEEE 802.3.*